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(54) Title: POLISHING PAD COMPRISING TRANSMISSIVE REGION

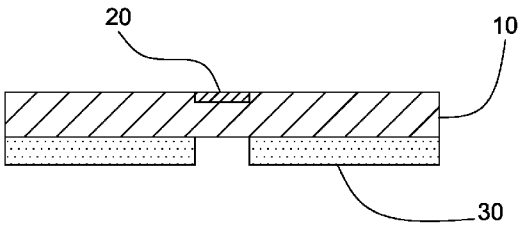


FIG. 1

(57) Abstract: The invention provides a polishing pad comprising an optically transrnissive region, wherein the polishing pad comprises a polisbing pad body comprising an opaque first region and an optically transmissive second region, wherein the second region has at least one recess formed therein of at least one part of the polishrag pad body, and at least one translucent window insert is integrated into the at least one recessed area. The polish ing pad body and the at ieast one translucent window insert comprise different porous.materials.

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